

Die Temperature (DieTemp)

1.60

DieTemp_1

DieTemp

Features

- Accuracy of ±5 °C
- Range –40 °C to +140 °C (0xFFD8 to 0x008C)
- Blocking and nonblocking API
- Supports only PSoC3 ES2 silicon with date code 1005 or later and Production PSoC3 silicon



The Die Temperature (DieTemp) component provides an API to acquire the temperature of the die. The System Performance Controller (SPC) is used to get the die temperature. The API includes blocking and nonblocking calls.

When to Use a DieTemp

Use a DieTemp component when you want to measure the die temperature of a device.

Input/Output Connections

There are no Input/Output Connections on the DieTemp component. It is a software component only.

Component Parameters

The DieTemp has no configurable parameters other than standard Instance Name and Built-in parameters.

Resources

	Digital Blocks					API Memory (Bytes)		
Analog Blocks	Datapaths	Macro cells	Status Registers	Control Registers	Counter7	Flash	RAM	Pins (per External I/O)
N/A	N/A	N/A	N/A	N/A	N/A	289	0	N/A

Application Programming Interface

Application Programming Interface (API) routines allow you to configure the component using software. The following table lists and describes the interface to each function. The subsequent sections cover each function in more detail.

By default, PSoC Creator assigns the instance name "DieTemp_1" to the first instance of a component in a given design. You can rename it to any unique value that follows the syntactic rules for identifiers. The instance name becomes the prefix of every global function name, variable, and constant symbol. For readability, the instance name used in the following table is "DieTemp."

Function	Description
DieTemp_Start()	Starts the SPC command to get the die temperature
DieTemp_Stop()	Stops the temperature reading
DieTemp_Query()	Queries the SPC to see if the temperature command is finished
DieTemp_GetTemp()	Sets up the command to get the temperature and blocks until finished

cystatus DieTemp_Start(void)

Description: Sends the command and parameters to the SPC to start a Die Temperature reading. This

function returns before the SPC finishes. If this function is called successfully, the SPC will

be locked and DieTemp Query() will have to be successfully called to unlock it.

CySpcUnlock() can also be called if the caller decides not to finish the temperature reading.

Parameters: void

Return Value: CYRET STARTED if the SPC command was started successfully.

CYRET_UNKNOWN if the SPC command failed.

CYRET LOCKED if the SPC was busy.

Side Effects: None

void DieTemp_Stop(void)

Description: Stops the temperature reading.

Parameters: None
Return Value: None
Side Effects: None



cystatus DieTemp_Query(int16 * temperature)

Description: Checks to see if the SPC command started by DieTemp Start() has finished. If the command

has not finished, the temperature value is not written. The caller will poll this function until the

command is complete.

Parameters: int16 * temperature: Address to store the temperature in degrees Celsius.

Return Value: CYRET_SUCCESS if the temperature command completed successfully.

CYRET_UNKNOWN if the there was an SPC failure.

CYRET STARTED if the temperature command has not completed.

CYRET_TIMEOUT if waited too long before reading data.

Side Effects: None

cystatus DieTemp_GetTemp(int16 * temperature)

Description: Sends the command and parameters to the SPC to start a Die Temperature reading and waits

until it fails or completes. After DieTemp_MAX_WAIT ticks, the function will return even if the

SPC has not finished. This is a blocking API.

Parameters: int16 * temperature: Address to store the temperature in degree of Celsius.

Return Value: CYRET SUCCESS if the command was completed successfully.

CYRET_TIMEOUT if the command times out.

Status codes from DieTemp_Start() or DieTemp_Query().

Side Effects: None

Sample Firmware Source Code

PSoC Creator provides numerous example projects that include schematics and example code in the Find Example Project dialog. For component-specific examples, open the dialog from the Component Catalog or an instance of the component in a schematic. For general examples, open the dialog from the Start Page or **File** menu. As needed, use the **Filter Options** in the dialog to narrow the list of projects available to select.

Refer to the "Find Example Project" topic in the PSoC Creator Help for more information.

DC and AC Electrical Characteristics

The following values indicate expected performance and are based on initial characterization data.

Para	ameter	Description	Conditions	Min	Typical	Max	Units
		Temp sensor accuracy	Range: -40 °C to +85 °C	-	±5		Ô



Component Changes

This section lists the major changes in the component from the previous version.

Version	Description of Changes	Reason for Changes / Impact		
1.60	The <i>DieTemp.c</i> file GetTemp API was edited to fix the power-on reset error output.	The DieTemp output on power-on reset was erroneous.		
1.50.a	Added characterization data to datasheet			
	Added information to the component that advertizes its compatibility with silicon revisions.	The tool returns an error/warns if the component is used on incompatible silicon. This component is not compatible with PSoC 3 ES2 or PSoC 5.		
	Minor datasheet edits and updates			
1.50	Switch from cydevice.h to cydevice_trm.h.	The <i>cydevice.h</i> file has been made obsolete, so the APIs and generated code provided with PSoC Creator are not included with <i>cydevice_trm.h</i> .		

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